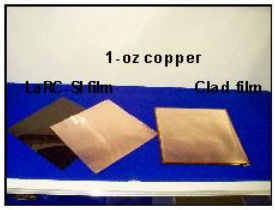
MULTI-LAYERED FLEX CIRCUIT FABRICATION

Clean environment
(glove box in a clean room)

2-Mil LaRC-SI film

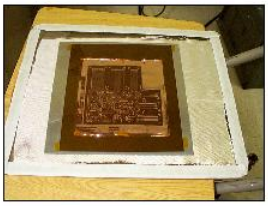


Copper cladding

Spinning photo resist

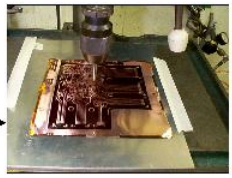
Art pattern exposure

Exposed & etched circuit layers

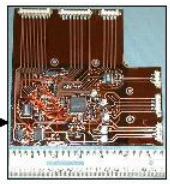


Stacking, aligning, & bagging layers

Autoclaving flex stack



Punching through Vias



Product: circuit